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1752-2 1.1		Web Site for Informat		-1752 Standa	ard				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Supplier Information															
Company Name *		Company Unique ID		Unique ID Au	uthority	Response Date *				Response Document ID					
SEMTECH CORPORATION 00-847-9941				DUNS		2014-	06-04								
Contact Name * Roya Motamedi		Title - Contact Quality Assurance Customer S		Phone - Cor (805) 389-27	Email - Contact * rmotamedi@semtech.com			om	Duplicate Contact -> Authorized Representative						
Authorized Representative *Title - RepresentativeRoya MotamediQuality Assurance				-	oresentative * 742	Email - Representative * rmotamedi@semtech.com				Supplier	Comme	nts or URL	for Add	litional I	nformation
Requester Item Number		Mfr Item Number		Mfr Item Name	Effectiv	ve Date	Version	Manufa	ufacturing Site		Weight *		M	Unit Type	
	SC2603SKTRT			Simple PWM Boost Controller			Mal			ysia 17.56		17.5625	mg	)	Each
Alternate Recommendation							Alternate Item 0			mments					
Manufacturing Proces	ss In	formation				•		•							
Terminal Plating / Grid Array	Materi	ial	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ating	Peak Proc	cess Body	Tempera	ature Ma	x Time at	Peak Temp	perature	Number	of Reflow Cycles
Matte Tin (Sn) CU Alloy			/ 1			260			; <b>30</b> seco			conds	ds 3		
Comments SC2603SKTRT is a REA	CH-co	ompliant product, pe	er EU Reg	ulation EC19	007/2006 to includ	le rece	nt additio	on of SVI	HC can	didate li	st of su	bstances i	in Dece	ember 2	013.

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields
<b>RoHS Material</b>	Composition Declara	tion				Declaration Type	* Detailed
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),
chromium, polybrominate excess of an applicable of gathered the information Company will rely on this completing this form, and certifications regarding the conditions of that agreen	ed biphenyls and/or polybrominated quantity limit, please indicate below it provides in this form using approp certification in determining the com I that Supplier may not have independent rein contributions to the part, and the nent, including any warranty rights a	which, if any, RoHS exemption you b priate methods to ensure its accuracy apliance of its products with European andently verified such information. Ho pose certifications are at least as comp	icted substance") in excess believe may apply. If the p y and that such information n Union member state laws bowever, in situations where prehensive as the certification that agreement, will be the s	of the applicable quantity limit bart is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independentl on in this paragraph. If the Co ole and exclusive source of the	identified above. If a homogene- evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges to y verified information provided by mpany and the Supplier enter into a Supplier's liability and the Comp	eous material within the part cont n shall encompass all such comp f the date that Supplier complete that Supplier may have relied on y others, Supplier agrees that, at to a written agreement with response upany's remedies for issues that a	tains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration
Declaration Si	gnature						
		C 1 1 11 C (1 1 )			· • • • • •	<b>T</b> 1: 10 11 1 4	D' i ll i

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			evel	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		РРМ
	Name		Material	weight	Measure			evei	Substance Category			Substance	CAS			Measure	-	+	
+I -I	DIE CHIP	+M -M	Silicon Die	1	mg	+C -	CSu	upplier		+S	-S	Silicon (Si)	7440-21-3		1	mg			56,939
+I -I	LEAD FRAME, SOT	+M -M	CDA194	7.8	mg	+C -	CSu	upplier		+S	-S	Copper (Cu)	7440-50-8		7.53402	mg			428,98
			-			+C -	·C A		Lead/Lead Compound	+S	-s	Lead	7439-92-1		0.0002	mg			13.32
						+C -	·C Su	upplier		+S	-s	Iron (Fe)	7439-89-6		0.17597	mg			10,019
							-			+S	-S	Phosphorous (P)	7723-14-0		0.00187	mg			106.59
										+S	-S	Zinc (Zn)	7440-66-6		0.00991	mg			564.04
										+S	-S	Silver (Ag)	7440-22-4		0.078	mg			4,441.2
+  -	DIE ATTACHED MA	+M -M	QMI519	0.07	mg	+C -	CSu	upplier		+S	-s	Silver (Ag)	7440-22-4		0.07	mg			3,786.4
. <u> </u>		, <b>.</b>								+S	-S	DiCycloPentenylOxyEth	68586-19-6		0.0032	mg			179.36
										+S	-S	DiCumyl Peroxide	80-43-3		0.0004	mg			19.93
+  -	WIRE BONDING	+M -M	Gold Wire	0.17	mg	+C -	CSu	upplier		+S	-S	Gold (Au)	7440-57-5		0.17	mg			9,679.7
+  -	ENCAPSULATION	+M -M	CEL-8240HF10	8.12	mg	+C -	CSu	upplier		+S	-S	Epoxy Resin-1	Proprietary		0.24	mg			13,870
			-							+S	-S	Epoxy Resin-2	Proprietary		0.24	mg			13,870
										+S	-S	Phenol Resin	Proprietary		0.37	mg			20,805
										+S	-S	Silica Fused	60676-86-0		7.09	mg			403,63
										+S	-S	Carbon Black	1333-86-4		0.02	mg			924.7
										+S	-S	Others	Proprietary		0.16	mg			9,246.9
+  -	LEAD FINISH	+M -M	Tin Solder Alloy	0.40248	mg	+C -	CSu	upplier		+S	-S	Tin	7440-31-5		0.40248	mg			22,917